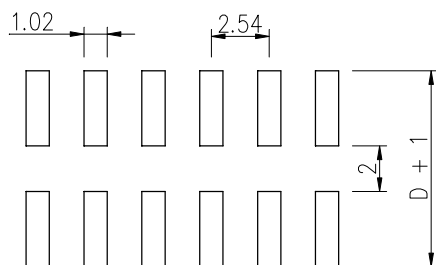


Recommended  
P.C. Board Layout



Contact Plating Type		
Full Gold Plating	Duplex Plating Gold Plated On Contact Area Tin Plated On Solder Area	Full Tin Plating
GF : Gold Flash G1 : Gold 3u" G2 : Gold 5u" G3 : Gold 10u" G4 : Gold 15u"	HF : Gold Flash, Tin 100u" H1 : Gold 3u", Tin 100u" H2 : Gold 5u", Tin 100u" H3 : Gold 10u", Tin 100u" H4 : Gold 15u", Tin 100u"	T1 : Tin 100u"

Specifications

Current Rating : 3 Amps  
 Insulator Resistance : 1000 Megohms min.  
 Contact Resistance : 20 m ohms max.  
 Dielectric Withstanding : AC 600V  
 Operating Temperature : -40°C ~ +105°C  
 Max. Processing Temp. : 230°C for 30~60 Seconds  
 (260°C for 10 Seconds)

Contact Material : Brass  
 Insulator Material : Polyester, UL 94V-0

Contact Plated : Full Gold, Full Tin, Selective Plated

Order Information

Serial Type — PA1 3 - 0 2 XX - X XX 0  
 Terminal Type —  
 3 : SMT Type  
 Row Type —  
 2 : Dual Rows  
 No. of Pin per Row —  
 Terminal Dim. —  
 1. AL=0.86 ,BL=5.84 ,D=7.60  
 2. AL=6.00 ,BL=6.00 ,D=7.50  
 3. AL=4.00 ,BL=0.32 ,D=7.50  
 4. AL=6.00 ,BL=1.50 ,D=7.50  
 5. AL=10.00 ,BL=1.20 ,D=7.50  
 6. AL=.... ,BL=.... ,D=....  
 Contact Plating —

TOLERANCE UNLESS SPECIFIED		朝富科技股份有限公司 JOIN TEK CORPORATION CO., LTD.	
LINEAR	ANGLE	SCALE	SHEET
.X ± 0.25	X° ± 5°	1/1	A
.XX ± 0.15	.X° ± 2°	名稱 : Pin Header P2.54mm TITLE Dual Rows, SMT Type	
.XXX ± 0.05	.XX° ± 1°	料號 : PA13-02XX-XGFO PART NO.	
日期	2006.01.05	製圖 SAM	
更改 REV.	設 變 內 容 MODIFICATION	修改 DRAWN	核准 APPROVED